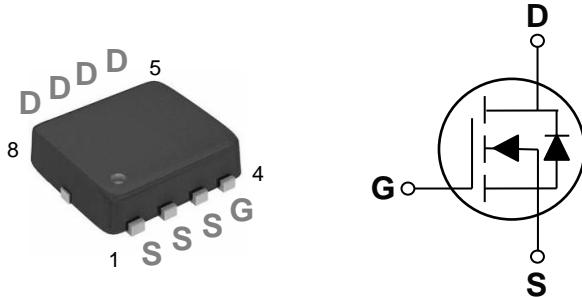


65V N-Channel MOSFETs

General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

PPAK 3X3 Pin Configuration



BVDSS	RDS(ON)	ID
65V	10.8mΩ	48A

Features

- 65V, 48A, RDS(ON) = 10.8mΩ @ VGS = 10V
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

Applications

- Motor Drive
- Power Tools
- LED Lighting
- Quick Charger

Absolute Maximum Ratings (T_c=25 °C unless otherwise noted)

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	65	V
V _{GS}	Gate-Source Voltage	+20/-12	V
I _D	Drain Current – Continuous (T _c =25 °C)	48	A
	Drain Current – Continuous (T _c =100 °C)	30.4	A
I _{DM}	Drain Current – Pulsed ¹	192	A
EAS	Single Pulse Avalanche Energy ²	51.2	mJ
IAS	Single Pulse Avalanche Current ²	32	A
P _D	Power Dissipation (T _c =25 °C)	42	W
	Power Dissipation – Derate above 25 °C	0.33	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction to ambient	---	62	°C/W
R _{θJC}	Thermal Resistance Junction to Case	---	2.98	°C/W

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Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=250\mu\text{A}$	65	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	BV_{DSS} Temperature Coefficient	Reference to 25°C , $I_{\text{D}}=1\text{mA}$	---	0.03	---	$\text{V}/^\circ\text{C}$
$I_{\text{DS}(\text{SS})}$	Drain-Source Leakage Current	$V_{\text{DS}}=60\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$	---	---	1	μA
		$V_{\text{DS}}=48\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=85^\circ\text{C}$	---	---	10	μA
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}}=+20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	100	nA

On Characteristics

$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance ³	$V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=15\text{A}$	---	9	10.8	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$, $I_{\text{D}}=12\text{A}$	---	16.3	19.5	$\text{m}\Omega$
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$, $I_{\text{D}}=250\mu\text{A}$	1	1.6	2.5	V
			---	-5	---	$\text{mV}/^\circ\text{C}$
g_{fs}	Forward Transconductance	$V_{\text{DS}}=10\text{V}$, $I_{\text{D}}=3\text{A}$	---	6	---	S

Dynamic and switching Characteristics

Q_g	Total Gate Charge ^{3, 4}	$V_{\text{DS}}=30\text{V}$, $V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=15\text{A}$	---	15.3	30.6	nC
Q_{gs}	Gate-Source Charge ^{3, 4}		---	2.4	5.8	
Q_{gd}	Gate-Drain Charge ^{3, 4}		---	5.4	10.8	
$T_{\text{d}(\text{on})}$	Turn-On Delay Time ^{3, 4}	$V_{\text{DD}}=30\text{V}$, $V_{\text{GS}}=10\text{V}$, $R_{\text{G}}=3.3\Omega$	---	10	20	ns
T_r	Rise Time ^{3, 4}		---	13.5	27	
$T_{\text{d}(\text{off})}$	Turn-Off Delay Time ^{3, 4}		---	28	56	
T_f	Fall Time ^{3, 4}		---	20	40	
C_{iss}	Input Capacitance	$V_{\text{DS}}=30\text{V}$, $V_{\text{GS}}=0\text{V}$, $F=1\text{MHz}$	---	945	1890	pF
C_{oss}	Output Capacitance		---	275	550	
C_{rss}	Reverse Transfer Capacitance		---	26	52	
R_g	Gate resistance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, $F=1\text{MHz}$	---	0.3	---	Ω

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_{SD}	Continuous Source Current	$V_{\text{G}}=V_{\text{D}}=0\text{V}$, Force Current	---	---	48	A
	Pulsed Source Current ³		---	---	96	A
V_{SD}	Diode Forward Voltage ³	$V_{\text{GS}}=0\text{V}$, $I_{\text{S}}=1\text{A}$, $T_J=25^\circ\text{C}$	---	---	1	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. $V_{\text{DD}}=50\text{V}$, $V_{\text{GS}}=10\text{V}$, $L=0.1\text{mH}$, $I_{\text{AS}}=32\text{A}$, $R_{\text{G}}=25\Omega$, Starting $T_J=25^\circ\text{C}$.
3. The data tested by pulsed, pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
4. Essentially independent of operating temperature.

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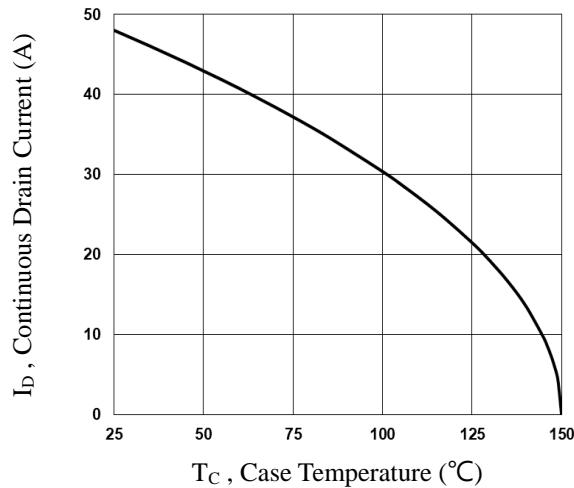


Fig.1 Continuous Drain Current vs. T_c

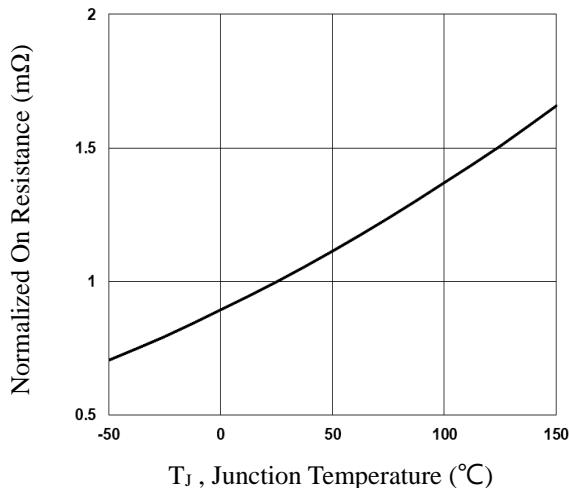


Fig.2 Normalized $R_{DS(ON)}$ vs. T_j

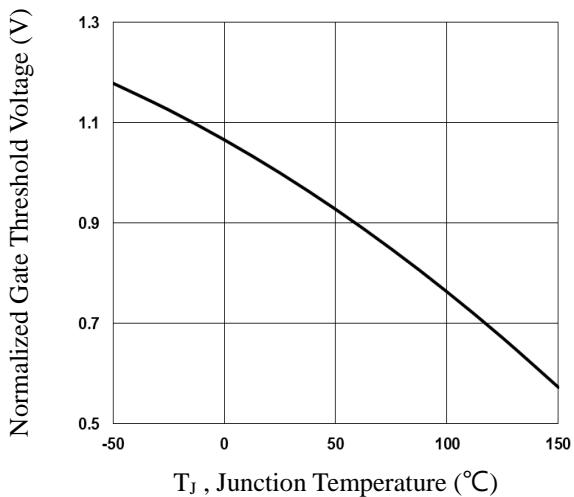


Fig.3 Normalized V_{th} vs. T_j

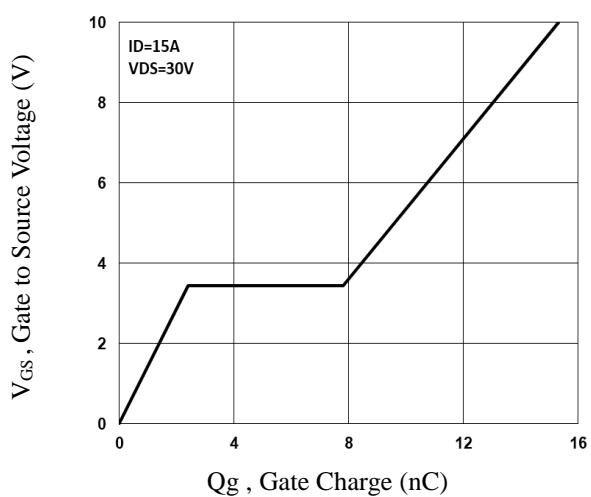


Fig.4 Gate Charge Waveform

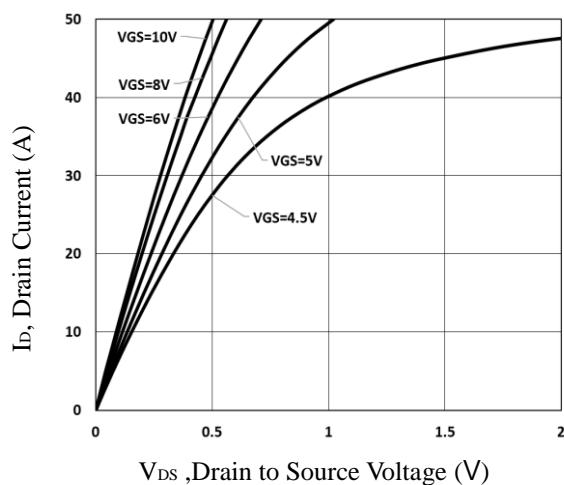


Fig.5 Typical Output Characteristics

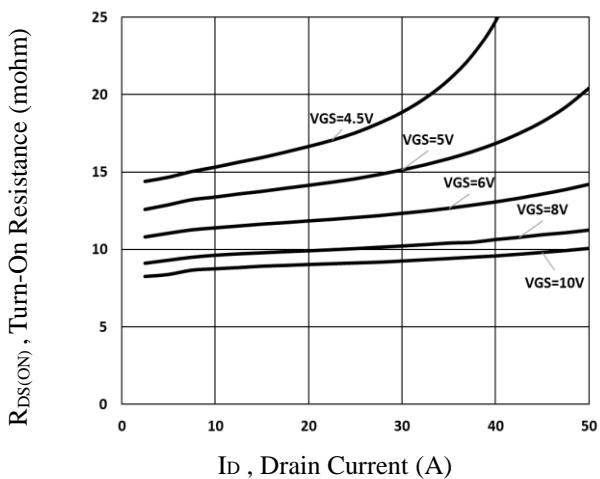
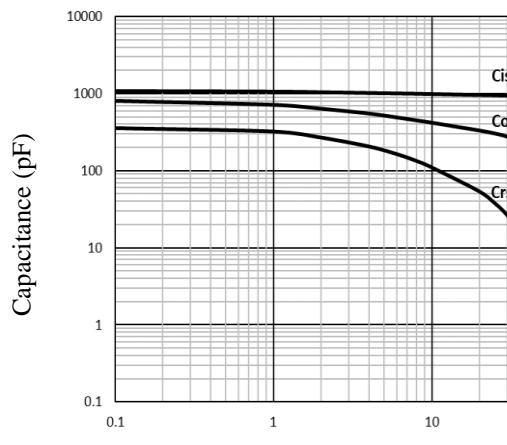


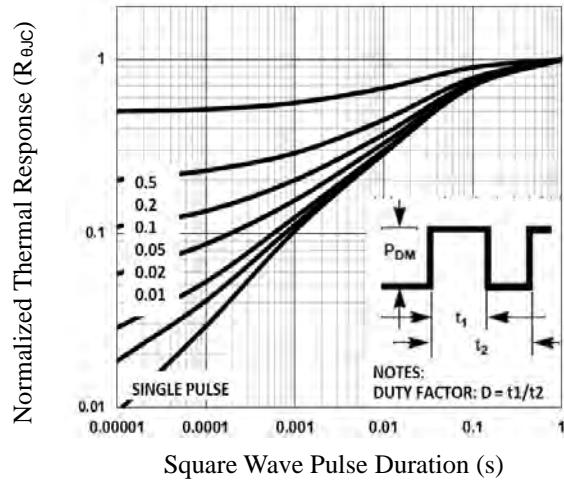
Fig.6 Turn-On Resistance vs. I_D

65V N-Channel MOSFETs



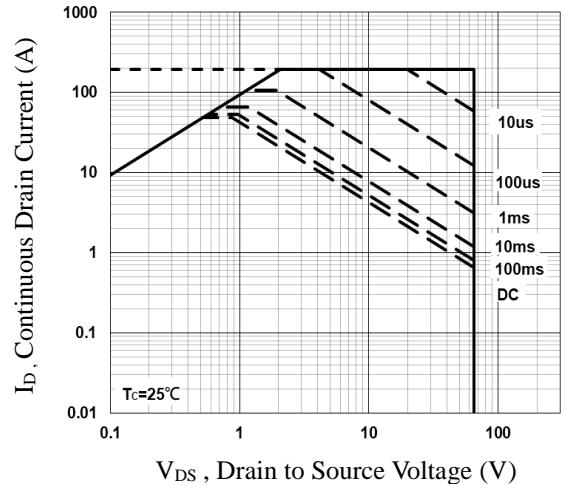
V_{DS} , Drain to Source Voltage (V)

Fig.7 Capacitance Characteristics



Square Wave Pulse Duration (s)

Fig.8 Normalized Transient Response



V_{DS} , Drain to Source Voltage (V)

Fig.9 Maximum Safe Operation Area

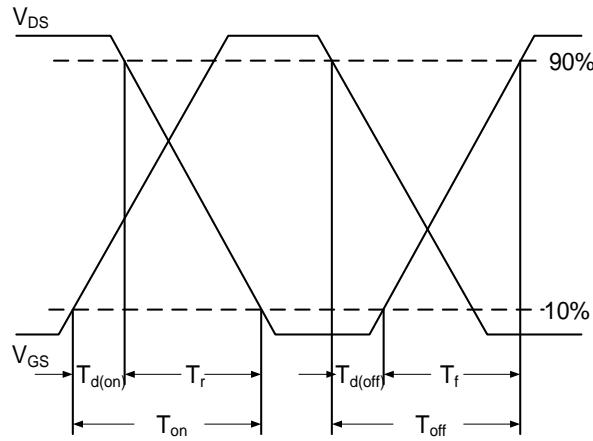


Fig.10 Switching Time Waveform

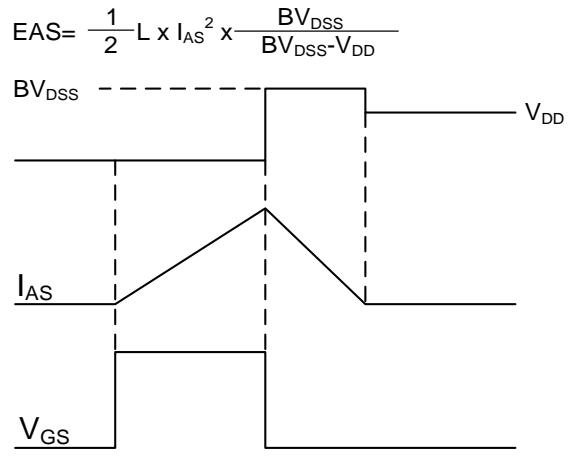
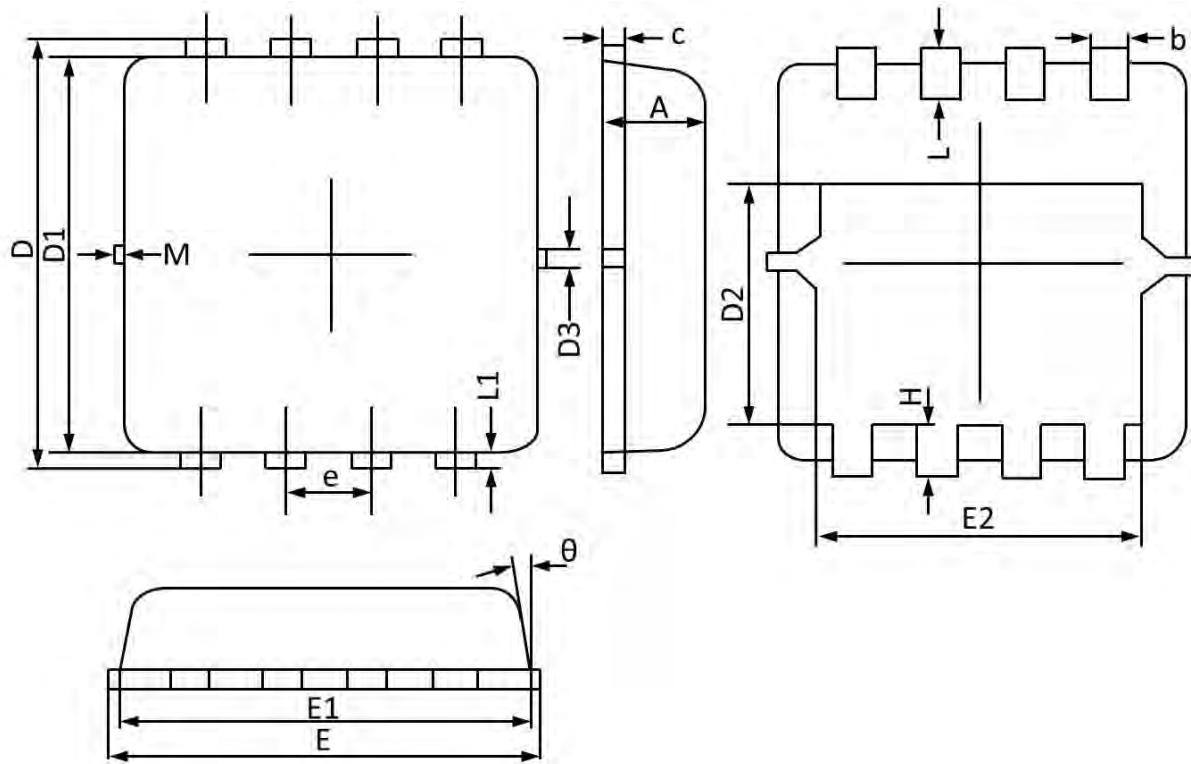


Fig.11 EAS Waveform

65V N-Channel MOSFETs

PPAK3X3 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.700	0.800	0.028	0.031
b	0.250	0.350	0.010	0.013
c	0.100	0.250	0.004	0.009
D	3.250	3.450	0.128	0.135
D1	3.000	3.200	0.119	0.125
D2	1.780	1.980	0.070	0.077
D3	0.130 REF		0.005 REF	
E	3.200	3.400	0.126	0.133
E1	3.000	3.200	0.119	0.125
E2	2.390	2.590	0.094	0.102
e	0.650 BSC		0.026 BSC	
H	0.300	0.500	0.011	0.019
L	0.300	0.500	0.011	0.019
L1	0.130 REF		0.005 REF	
θ	0°	12°	0°	12°
M	0.150 REF		0.006 REF	